

**60 V, 57 A, 7.0 mΩ Low RDS(ON)
N ch Trench Power MOSFET
EKI06108**



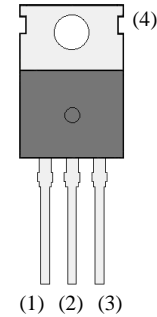
Data Sheet

Features

- $V_{(BR)DSS}$ ----- 60 V ($I_D = 100 \mu A$)
- I_D ----- 57 A
- $R_{DS(ON)}$ ----- 9.2 mΩ max. ($V_{GS} = 10 V, I_D = 28.5 A$)
- Q_g ----- 16.9 nC ($V_{GS} = 4.5 V, V_{DS} = 30 V, I_D = 28.5 A$)
- Low Total Gate Charge
- High Speed Switching
- Low On-Resistance
- Capable of 4.5 V Gate Drive
- 100 % UIL Tested
- RoHS Compliant

Package

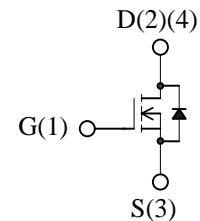
- TO220-3L



Not to scale

Applications

- DC-DC converters
- Synchronous Rectification
- Power Supplies



Absolute Maximum Ratings

- Unless otherwise specified, $T_A = 25 \text{ }^\circ\text{C}$

| Parameter | Symbol | Test conditions | Rating | Unit |
|---|-----------|---|-------------|------------------|
| Drain to Source Voltage | V_{DS} | | 60 | V |
| Gate to Source Voltage | V_{GS} | | ± 20 | V |
| Continuous Drain Current | I_D | $T_C = 25 \text{ }^\circ\text{C}$ | 57 | A |
| Pulsed Drain Current | I_{DM} | $PW \leq 100 \mu s$ Duty cycle $\leq 1 \%$ | 114 | A |
| Continuous Source Current (Body Diode) | I_S | | 57 | A |
| Pulsed Source Current (Body Diode) | I_{SM} | $PW \leq 100 \mu s$ Duty cycle $\leq 1 \%$ | 114 | A |
| Single Pulse Avalanche Energy | E_{AS} | $V_{DD} = 30 V, L = 1 mH,$ $I_{AS} = 9.4 A, \text{ unclamped,}$ $R_G = 4.7 \Omega$ Refer to Figure 1 | 89 | mJ |
| Avalanche Current | I_{AS} | | 16.7 | A |
| Power Dissipation | P_D | $T_C = 25 \text{ }^\circ\text{C}$ | 90 | W |
| Operating Junction Temperature | T_J | | 150 | $^\circ\text{C}$ |
| Storage Temperature Range | T_{STG} | | - 55 to 150 | $^\circ\text{C}$ |

Thermal Characteristics

- Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$

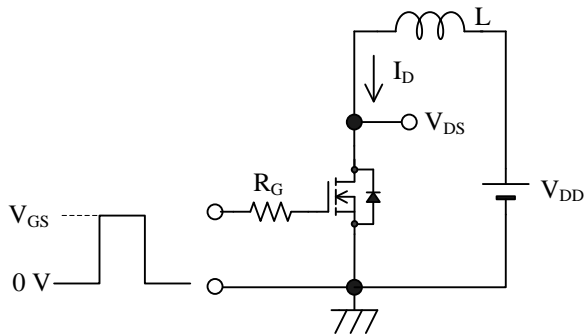
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|---|-----------------|-----------------|------|------|------|--------------------|
| Thermal Resistance (Junction to Case) | $R_{\theta JC}$ | | – | – | 1.4 | $^\circ\text{C/W}$ |
| Thermal Resistance (Junction to Ambient) | $R_{\theta JA}$ | | – | – | 62.5 | $^\circ\text{C/W}$ |

Electrical Characteristics

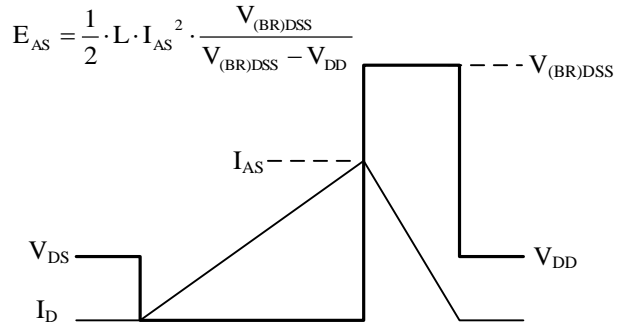
- Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---------------|--|------|------|-----------|------------------|
| Drain to Source Breakdown Voltage | $V_{(BR)DSS}$ | $I_D = 100\text{ }\mu\text{A}$, $V_{GS} = 0\text{ V}$ | 60 | – | – | V |
| Drain to Source Leakage Current | I_{DSS} | $V_{DS} = 60\text{ V}$, $V_{GS} = 0\text{ V}$ | – | – | 100 | μA |
| Gate to Source Leakage Current | I_{GSS} | $V_{GS} = \pm 20\text{ V}$ | – | – | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 650\text{ }\mu\text{A}$ | 1.0 | 2.0 | 2.5 | V |
| Static Drain to Source On-Resistance | $R_{DS(on)}$ | $I_D = 28.5\text{ A}$, $V_{GS} = 10\text{ V}$ | – | 7.0 | 9.2 | $\text{m}\Omega$ |
| | | $I_D = 14.3\text{ A}$, $V_{GS} = 4.5\text{ V}$ | – | 8.6 | 11.2 | $\text{m}\Omega$ |
| Gate Resistance | R_G | $f = 1\text{ MHz}$ | – | 1.5 | – | Ω |
| Input Capacitance | C_{iss} | $V_{DS} = 25\text{ V}$ $V_{GS} = 0\text{ V}$ $f = 1\text{ MHz}$ | – | 2520 | – | pF |
| Output Capacitance | C_{oss} | | – | 280 | – | |
| Reverse Transfer Capacitance | C_{rss} | | – | 135 | – | |
| Total Gate Charge ($V_{GS} = 10\text{ V}$) | Q_{g1} | $V_{DS} = 30\text{ V}$ $I_D = 28.5\text{ A}$ | – | 36.2 | – | nC |
| Total Gate Charge ($V_{GS} = 4.5\text{ V}$) | Q_{g2} | | – | 16.9 | – | |
| Gate to Source Charge | Q_{gs} | | – | 6.1 | – | |
| Gate to Drain Charge | Q_{gd} | | – | 5.4 | – | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 30\text{ V}$ $I_D = 28.5\text{ A}$ $V_{GS} = 10\text{ V}$, $R_G = 4.7\text{ }\Omega$ Refer to Figure 2 | – | 4.5 | – | ns |
| Rise Time | t_r | | – | 5.0 | – | |
| Turn-Off Delay Time | $t_{d(off)}$ | | – | 21.6 | – | |
| Fall Time | t_f | | – | 10.7 | – | |
| Source to Drain Diode Forward Voltage | V_{SD} | $I_S = 28.5\text{ A}$, $V_{GS} = 0\text{ V}$ | – | 0.9 | 1.5 | V |
| Source to Drain Diode Reverse Recovery Time | t_{rr} | $I_F = 28.5\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$ Refer to Figure 3 | – | 34.8 | – | ns |
| Source to Drain Diode Reverse Recovery Charge | Q_{rr} | | – | 42.3 | – | nC |

Test Circuits and Performance Curves

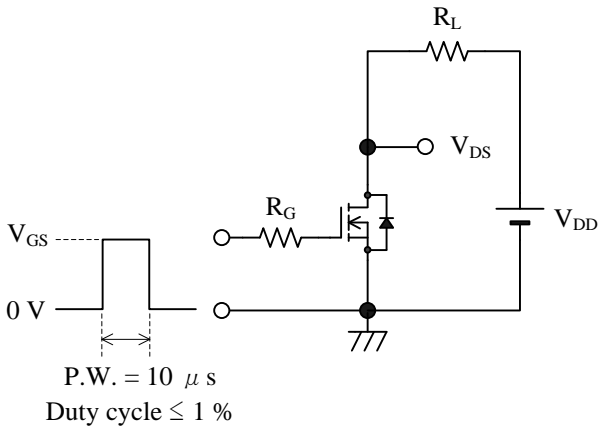


(a) Test Circuit

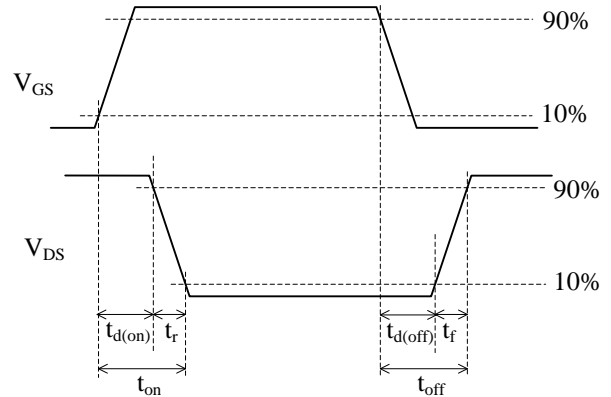


(b) Waveform

Figure 1. Unclamped Inductive Switching

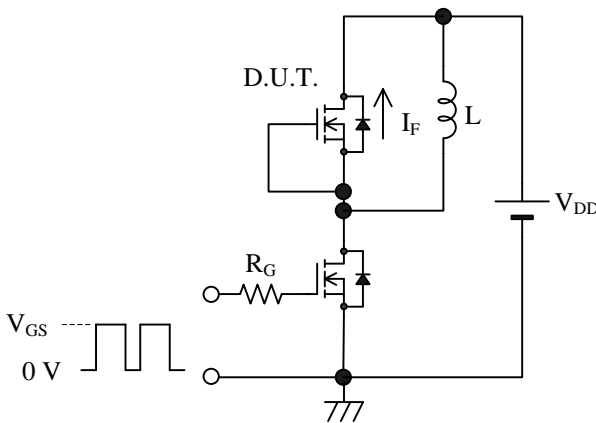


(a) Test Circuit

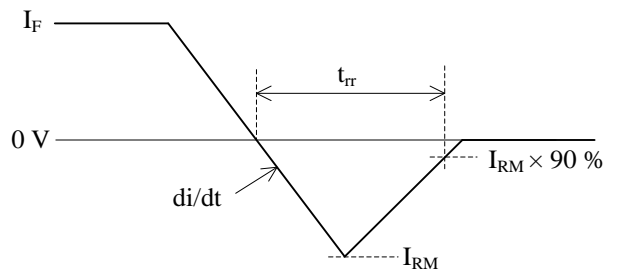


(b) Waveform

Figure 2. Switching Time

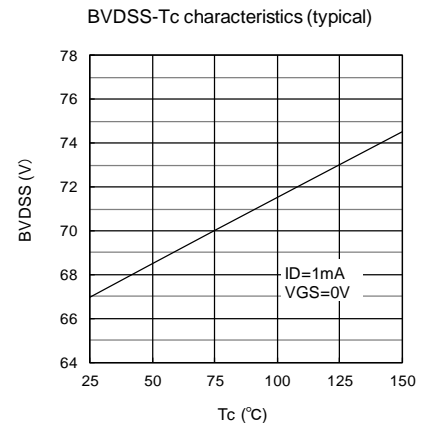
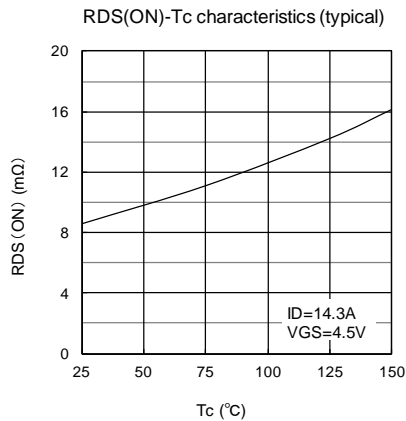
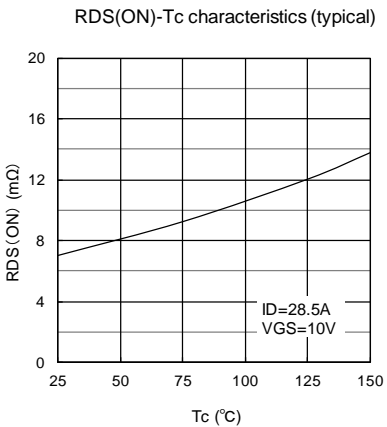
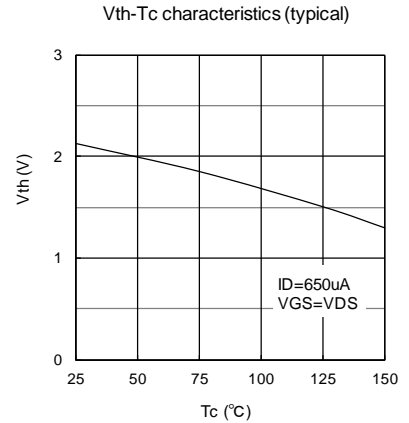
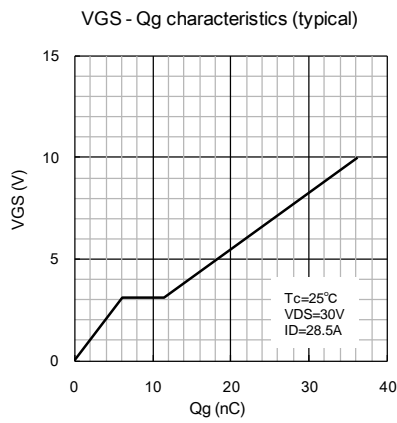
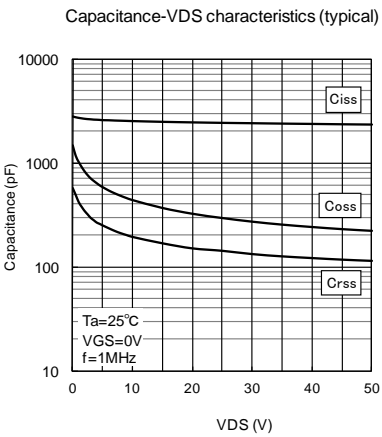
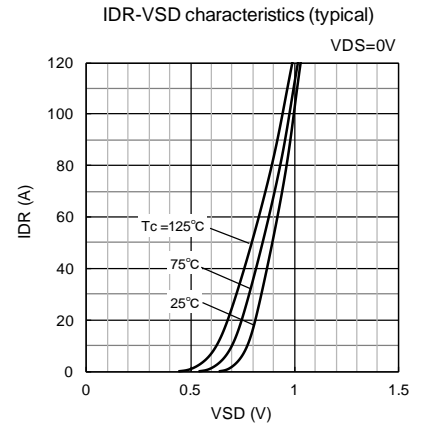
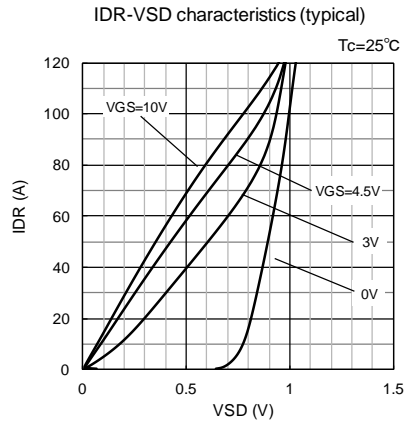
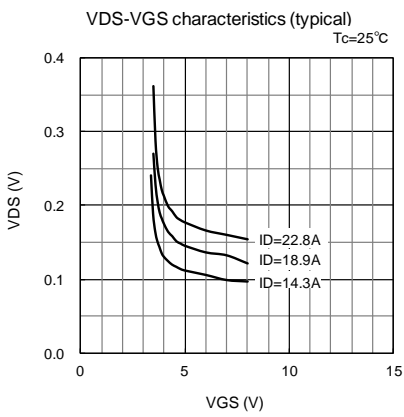
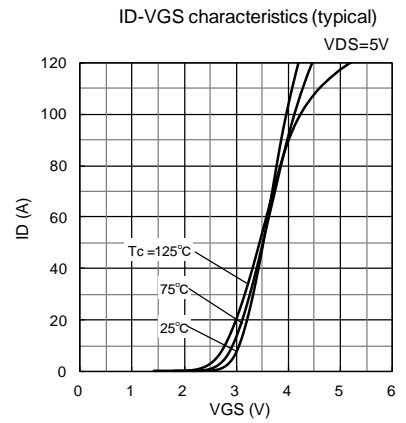
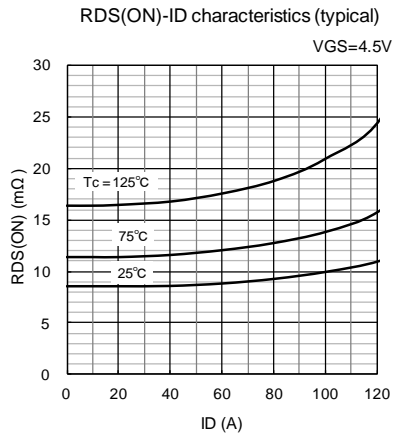
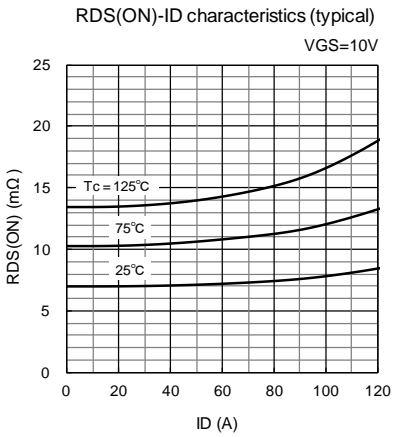


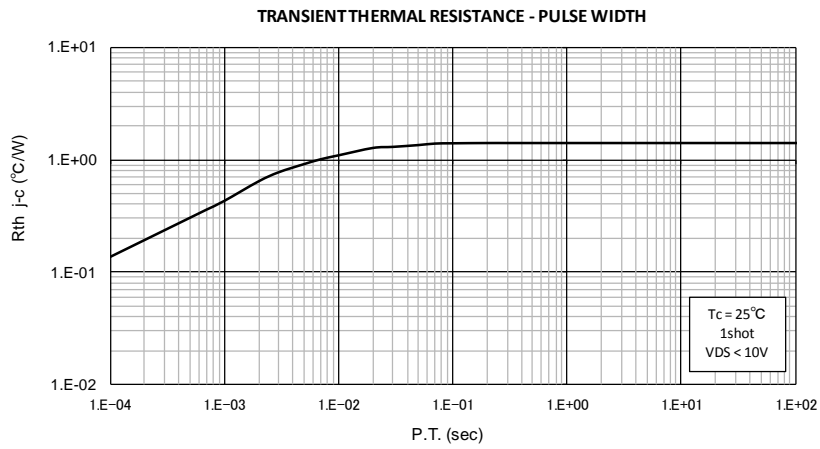
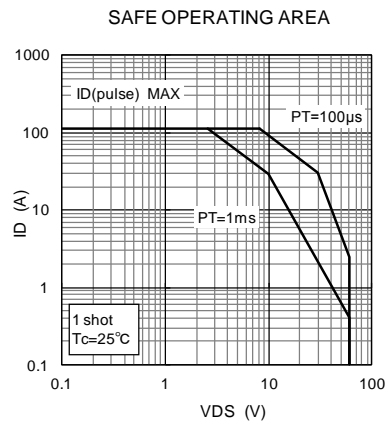
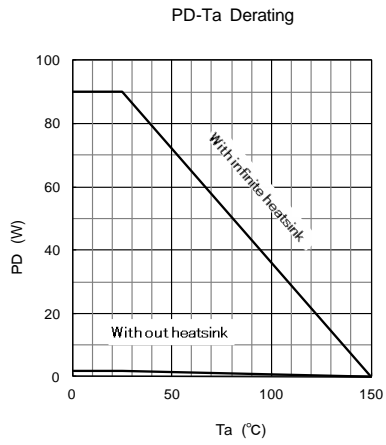
(a) Test Circuit



(b) Waveform

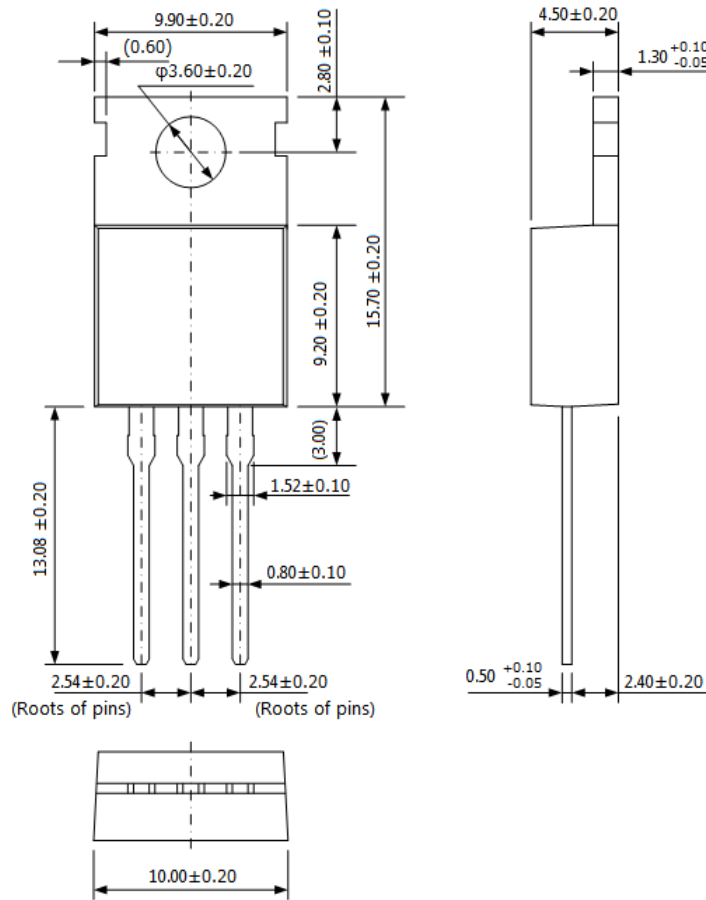
Figure 3. Diode Reverse Recovery Time





Physical Dimensions

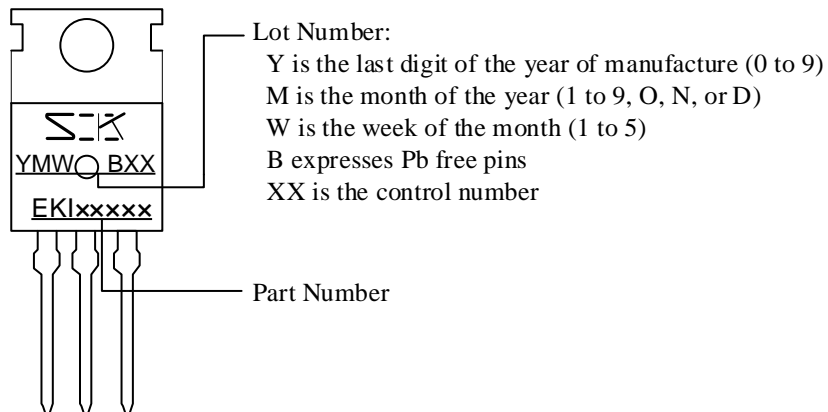
- TO220-3L



NOTES:

- Dimensions in millimeters
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:
 Flow: 260 ± 5 °C / 10 ± 1 s, 2 times
 Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time
 Soldering should be at a distance of at least 1.5 mm from the body of the product.
- Recommended screw torque for TO220: 0.490 N·m to 0.686 N·m (5 kgf·cm to 7 kgf·cm)

Marking Diagram



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